



APT6013JFLL

600V 39A 0.130Ω

## POWER MOS 7™

FREDFET

Power MOS 7™ is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7™ by significantly lowering  $R_{DS(ON)}$  and  $Q_g$ . Power MOS 7™ combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.

- Lower Input Capacitance
- Increased Power Dissipation
- Lower Miller Capacitance
- Easier To Drive
- Lower Gate Charge,  $Q_g$
- Popular SOT-227 Package
- FAST RECOVERY BODY DIODE

## MAXIMUM RATINGS

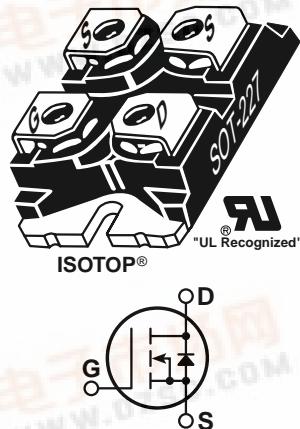
All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT6013JFLL	UNIT
$V_{DSS}$	Drain-Source Voltage	600	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	39	Amps
$I_{DM}$	Pulsed Drain Current ①	156	
$V_{GS}$	Gate-Source Voltage Continuous	$\pm 30$	
$V_{GSM}$	Gate-Source Voltage Transient	$\pm 40$	Volts
$P_D$	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	460	Watts
	Linear Derating Factor	3.68	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	300	
$I_{AR}$	Avalanche Current ① (Repetitive and Non-Repetitive)	39	Amps
$E_{AR}$	Repetitive Avalanche Energy ①	50	
$E_{AS}$	Single Pulse Avalanche Energy ④	2500	mJ

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$ )	600			Volts
$I_{D(on)}$	On State Drain Current ② ( $V_{DS} > I_{D(on)} \times R_{DS(on)}$ Max, $V_{GS} = 10\text{V}$ )	39			Amps
$R_{DS(on)}$	Drain-Source On-State Resistance ② ( $V_{GS} = 10\text{V}$ , $0.5 I_{D[Cont.]}$ )			0.130	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = V_{DSS}$ , $V_{GS} = 0\text{V}$ )			250	$\mu\text{A}$
	Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}$ , $V_{GS} = 0\text{V}$ , $T_C = 125^\circ\text{C}$ )			1000	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 30\text{V}$ , $V_{DS} = 0\text{V}$ )			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 2.5\text{mA}$ )	3		5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

## DYNAMIC CHARACTERISTICS

APT6013JFLL

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		5640		pF
$C_{oss}$	Output Capacitance			1010		
$C_{rss}$	Reverse Transfer Capacitance			63		
$Q_g$	Total Gate Charge <sup>③</sup>	$V_{GS} = 10V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D[\text{Cont.}] @ 25^\circ C$		129		nC
$Q_{gs}$	Gate-Source Charge			30		
$Q_{gd}$	Gate-Drain ("Miller") Charge			58		
$t_d(\text{on})$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D[\text{Cont.}] @ 25^\circ C$ $R_G = 0.6\Omega$		16		ns
$t_r$	Rise Time			11		
$t_d(\text{off})$	Turn-off Delay Time			29		
$t_f$	Fall Time			5		

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$I_S$	Continuous Source Current (Body Diode)			39	Amps
$I_{SM}$	Pulsed Source Current <sup>①</sup> (Body Diode)			156	
$V_{SD}$	Diode Forward Voltage <sup>②</sup> ( $V_{GS} = 0V$ , $I_S = -I_D[\text{Cont.}]$ )			1.3	Volts
$dv/dt$	Peak Diode Recovery $dv/dt$ <sup>⑤</sup>			15	V/ns
$t_{rr}$	Reverse Recovery Time ( $I_S = -I_D[\text{Cont.}]$ , $di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$		250	ns
		$T_J = 125^\circ C$		500	
$Q_{rr}$	Reverse Recovery Charge ( $I_S = -I_D[\text{Cont.}]$ , $di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$		1.6	$\mu C$
		$T_J = 125^\circ C$		5.5	
$I_{RRM}$	Peak Recovery Current ( $I_S = -I_D[\text{Cont.}]$ , $di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$		15	Amps
		$T_J = 125^\circ C$		27	

## THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.27	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

③ See MIL-STD-750 Method 3471

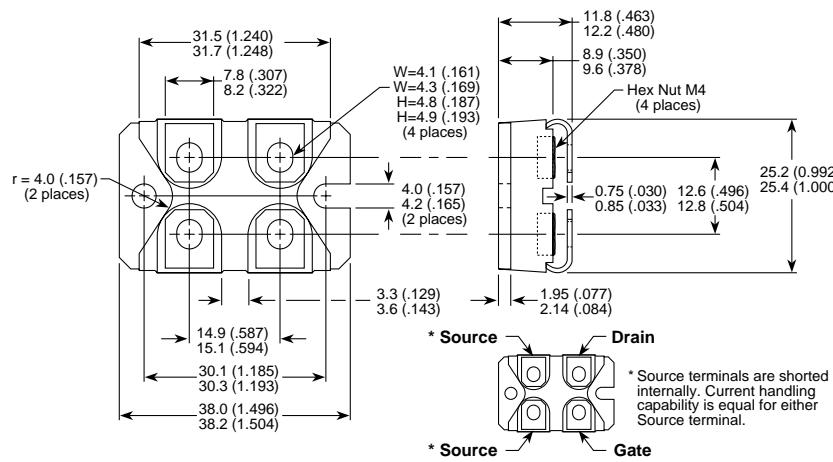
② Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%

④ Starting  $T_J = +25^\circ C$ ,  $L = 3.29mH$ ,  $R_G = 25\Omega$ , Peak  $I_L = 39A$

⑤  $dv/dt$  numbers reflect the limitations of the test circuit rather than the device itself.  $I_S \leq -I_D[\text{Cont.}]$   $dv/dt \leq 700A/\mu s$   $V_R \leq V_{DSS}$   $T_J \leq 150^\circ C$

APT Reserves the right to change, without notice, the specifications and information contained herein.

## SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)